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Designation: F 68–99 (Reapproved 2004) Designation: F 68 – 05<sup>ε1</sup>

# Standard Specification for **Oxygen-Free Copper in Wrought Forms for Electron** Devices<sup>1</sup>

This standard is issued under the fixed designation F 68; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last reapproval. A superscript epsilon ( $\varepsilon$ ) indicates an editorial change since the last revision or reapproval.

Note-Section 2 was corrected editorially in August 2009.

#### 1. Scope\*

1.1 This specification establishes the requirements for wrought and fabricated shapes made from Copper UNS<sup>2</sup> No. C10100, conforming to the chemical requirements of Specification B 170, Grade 1, and suitable for use in electron devices.

1.2 The requirements of this specification are in addition to those prescribed in the following product specifications appropriate to the material being ordered: B 1, B 2, B 75, B 75M, B 152/B 152M, B 170, B 187/B 187M, B 272, and B 372. In case of conflict, however, this specification shall take precedence.

1.3 The inch-pound units are the standard for this specification except for grain sizes which are in metric units. Metric values given in parentheses are for information only.

1.4 The following safety hazard caveat applies to sections 17.4, 17.5 and 18.7 of this specification: This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to establish appropriate safety and health practices and determine the applicability of regulatory limitations prior to use.

#### 2. Referenced Documents

2.1 The following documents in the current issue of the Book of Standards form a part of this specification to the extent referenced herein:

2.2

2.1 ASTM Standards:<sup>3</sup>

B1 Specification for Hard-Drawn Copper Wire Preview

B 2 Specification for Medium-Hard-Drawn Copper Wire

<del>B3</del>

B 3 Specification for Soft or Annealed Copper Wire

B 75 Specification for Seamless Copper Tube

B 75M Specification for Seamless Copper Tube (Metric)<sup>38d9e-cad7-4c0f-ac53-fb0a9b2575f8/astm-f68-05e1</sup>

B 152/B 152M Specification for Copper Sheet, Strip, Plate and Rolled Bar

B 170 Specification for Oxygen-Free Electrolytic Copper—Refinery Shapes

B 187/B 187M Specification for Copper Bar, Bus Bar, Rod and Shapes

**B188** 

<u>B 188</u> Specification for Seamless Copper Bus Pipe and Tube

B 193 Test Method for Resistivity of Electrical Conductor Materials

B 248 Specification for General Requirements for Wrought Copper and Copper-Alloy Plate, Sheet, Strip and Rolled Bar B248M

B 248M Specification for General Requirements for Wrought Copper and Copper-Alloy Plate, Sheet, Strip and Rolled Bar [Metric]

B 249/B 249M Specification for General Requirements for Wrought Copper and Copper-Alloy Rod, Bar, Shapes, and Forgings B 250/B 250M Specification for General Requirements for Wrought Copper-Alloy Wire

#### \*A Summary of Changes section appears at the end of this standard.

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<sup>&</sup>lt;sup>1</sup> This specification is under the jurisdiction of ASTM Committee B05 on Copper and Copper Alloys and is the direct responsibility of Subcommittee B05.02 on Rod, Bar, Wire, Shapes, Shapes and Forgings.

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<sup>&</sup>lt;sup>2</sup> The UNS System for copper and copper alloys (see Practice E 527) is a simple expansion of the former standard designation system accomplished by the addition of a prefix "C" and a suffix "00". The suffix can be used to accommodate composition variations of the base alloy.

<sup>&</sup>lt;sup>3</sup> For referenced ASTM standards, visit the ASTM website, www.astm.org, or contact ASTM Customer Service at service@astm.org. For Annual Book of ASTM Standards volume information, refer to the standard's Document Summary page on the ASTM website.

B 272 Specification for Copper Flat Products with Finished (Rolled or Drawn) Edges (Flat Wire and Strip)

B 372 Specification for Seamless Copper and Copper-Alloy Rectangular Waveguide Tube

B 577 Test Methods for Detection of Cuprous Oxide Hydrogen Embrittlement Susceptibility in Copper

E 29 Practice for Using Significant Digits in Test Data to Determine Conformance with Specifications

E 112 Test Methods for Determining Average Grain Sizes

E 527 Practice for Numbering Metals and Alloys (UNS)

 $\frac{2.3}{2.3}$ 

2.2 ASTM Adjunct:

Comparison Chart<sup>4</sup>

## 3. Terminology

3.1 For definitions of terms related to this product, refer to the terminology sections of Specifications B 3, B 188, B 248, B 248M, B 249/B 249M, B 250/B 250M, or B 251.

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3.2 Definition of Terms Specific to This Standard:

3.2.1 *extrusion pipe*, *n*—a lamination resulting from the flow of the oxide surface of a billet into the article being extruded and usually confined to the trailing-end portion of the extruded product.

3.2.2 oxygen-free, adj—electrolytic copper produced substantially free of cuprous oxide and containing no more than 10 ppm oxygen, as determined by metallographic examination at  $75 \times$  under polarized light, and manufactured without the use of metallic or metalloidal deoxidizers.

3.2.3 oxygen-free, grade 1, adj—as defined in 3.2.2 except that the oxygen content must be 5 ppm maximum. This copper is also commonly termed "oxygen-free electronic."

3.2.4 rms, n—root-mean-square, a statistical measure of surface roughness usually determined by means of a profilometer.

## 4. Ordering Information

4.1 Orders for the product shall include the following information:

- 4.1.1 The designation and year of issue of both Specification F 68 and the basic product specification involved,
- 4.1.2 Shape of product,
- 4.1.3 Size,
- 4.1.4 Total estimated weight or number of pieces, or both, for each size and shape,
- 4.1.5 The Specification F 68 Class of material,
- 4.1.6 Intended application (for example, wave guide), 1011 Preview
- 4.1.7 Temper,
- 4.1.8 Heat identification or traceability details,
- 4.1.9 Certification,

- 4.2 The following options are available: tandards/sist/99438d9e-cad7-4c0f-ac53-fb0a9b2575f8/astm-f68-05e1
- 4.2.1 Mill test report,
- 4.2.2 Special packaging,
- 4.2.3 Special marking.

## 5. Materials and Manufacture

## 5.1 Material:

5.1.1TheMaterial—The material shall be oxygen-free electronic copper which conforms to the requirements of Specification B 170, Grade 1.

5.2 Manufacture:

5.2.1The Manufacture—The manufacturing process shall conform to the requirements of this specification and to the basic product specification to which the product was ordered.

## 6. Chemical Composition

6.1 The cast refinery shape shall conform to the requirements specified in Specification B 170, Grade 1, Table 1.

6.1.1 Copper shall be taken as the difference between the sum of results for Grade 1 specified elements and 100 %.

6.2 These composition limits do not preclude the possible presence of other unnamed elements. Limits may be established and analysis required for unnamed elements by agreement between the manufacturer and the purchaser.

## 7. Temper

7.1 The temper of the wrought or fabricated product supplied shall conform to the requirements of the basic product specification to which it was ordered.

Available from ASTM International Headquarters. Order Adjunct No. ADJF0068.

Available from ASTM International Headquarters. Order Adjunct No. . Original adjunct produced in 1966 .

#### 8. Physical Properties

#### 8.1 Electrical Resistivity:

<u>8.1.1TheResistivity—The</u> maximum mass resistivity shall be 0.15176 ohms g/m<sup>2</sup> (conductivity 101.0 % minimum, International Annealed Copper Standard <u>{IACS}(IACS)</u> at 20°C when tested in the annealed condition.

8.2 Scaling:

8.2.1The <u>Scaling</u>—When agreed upon between customer and supplier, the test specimens of oxygen-free copper shall show substantial surface oxide adherence when subjected to test as described in <del>15.3.</del> 18.7.

NOTE 1-The purpose of this test is to distinguish between oxygen free and deoxidized copper. Deoxidized copper will not retain the surface oxide in this test.

#### 9. Mechanical Properties

9.1 All products shall conform to the mechanical property requirements of the basic product specification to which the item was ordered, with the following exception:

9.1.1 Sheet and strip with a thickness of 0.125 in. or less and intended for gaskets or for deep drawing shall conform to the requirements prescribed in Table 1.

#### 10. Hydrogen Embrittlement (Reverse Bend Test Method)

10.1 Specimens shall withstand a minimum of ten reverse bends without breaking. Evidence of blisters, upon visual examination, shall be cause for rejection.

NOTE 2—Fractured areas of the bent samples should show some reduction in area and have a distorted, smeared surface. The ideal break will have the appearance of a cup and cone tensile failure.

#### **11. General Examination**

11.1 When examined the samples shall have:

11.1.1 A relatively uniform surface free of irregular rough spots sometimes termed open grains,

11.1.2 Edges free of seams, laps and cracks,

11.1.3 Cross sections free of breaks, inclusions or extrusion pipe.

## **12.** Special Examinations

## 12.1 Special Macro Examination:

12.1.1 The samples shall show no subsurface defects in excess of the following limits:

12.1.1.1 Tubular Products:

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(1) Tubes for Exhaust (Pinch-off) Purposes: (a.1)For (a) For wall thickness over 0.1 in. (2.5 mm), no defects on the external surface deeper than 0.005 in. (0.13 mm).

(a.2)For <u>(b)</u> For wall thicknesses up to 0.1 (2.5 mm) inclusive, no defects on the external surface deeper than 5 % of the wall thickness.

 $\frac{(a.3)No}{(a.3)No}$  (c) No significant defects on the inside surface when examined with fiber optics or a boroscope.

(b)(2) Waveguides—No defects on the external surface deeper than 0.005 in. (0.13 mm) or 5 % of the wall thickness, whichever is smaller. No significant defects on the inside surface when examined with fiber optics or a boroscope.

<del>(e)</del>

 $\left( a\right)$ 

(3) Tube for Other Applications—No defects on either the internal or external surfaces deeper than 0.020 in. (0.51 mm) or 5 % of the wall thickness, whichever is the smaller.

12.1.1.2 *Bar and Plate Products*—No defects deeper than 0.06 in. (1.6 mm) or 5 % of the thickness, whichever is the smaller. 12.1.1.3 *Sheet, Strip and Flat Wire Products*—No defects deeper than 0.005 in. (0.13 mm) or 5 % of the thickness, whichever is smaller.

12.1.1.4 Rod and Wire Products:

(a)(1)\_Rod and Wire less than 0.19 in. (4.8 mm) in Diameter:Diameter

(a.1)No No defects deeper than 0.005 in. (0.13 mm) or 5 % of the diameter, whichever is smaller.

(b)(2) Rod and Wire 0.19 in. (4.8 mm) and Over in Diameter:Diameter

(b.1)NoNo defects deeper than 0.06 in. (1.6 mm) or 5 % of the diameter, whichever is smaller.

TABLE 1 Grain Size	
Average Grain Size, max, mm	Hardness HRF <sup>A</sup> max
0.035	75
0.050	75
	Average Grain Size, max, mm 0.035

<sup>A</sup> For information only.

12.2 Special Microscopical Examination:

12.2.1 Samples shall be classified by comparison to Plate 1, which is available from ASTM International Headquarters as an adjunct (see 2.32.2).

12.2.1.1 Product whose samples have an appearance in conforming to either Class 1 or Class 2 shall be considered acceptable.

12.2.1.2 Subsurface microporosity similar to those typical of Class 3, 4 or 5 as illustrated in Plate 1, are permissible in Class 1 and 2 material provided the microporosity does not appear below the metal surface at depths exceeding the following:

<del>(a)</del>

(1) Tubular Products:

<del>(a.1)</del>

(a) Tubes for Exhaust Purposes and Waveguides—No indications at any depth below the surface.

<del>(a.2)</del>

<u>(b)</u> Tubes for Other Applications — Microporosity permissible to depths of 0.020 in. (0.51 mm) or 5 % of the tube wall, whichever is smaller.

<del>(b)</del>

(2) Bar and Plate—Microporosity permissible to depths of 0.06 in. (1.5 mm) or 5 % of the thickness, whichever is smaller. (c)

(3) Sheet, Strip and Flat Wire—Microporosity permissible to depths of 0.010 in. (0.25 mm) or 5 % of the thickness, whichever is smaller.

<del>(d)</del>

(4) Rod and Wire Products:

<del>(d.1)</del>

<u>(a)</u> Rod and Wire less than 0.19 in. (4.8 mm) in Diameter—Microporosity permissible to depths of 0.010 in. (0.25 mm) or 5 % of the diameter or thickness, whichever is smaller.

<del>(d.2)</del>

(b) Rod and Wire 0.19 in. (4.8 mm) and Over in Diameter—Microporosity permissible to depths of 0.06 in. (1.5 mm) or 5 % of the diameter or thickness, whichever is the smaller.

12.2.1.3 Product whose samples have an appearance corresponding to Class 3, 4 or 5 and not in conformance with 12.2.1.2, shall be acceptable only by agreement between the manufacturer or supplier and the purchaser.

## 13. Dimensions, Mass and Permissible Variations

13.1 The dimensional tolerances for the product described by this specification shall be as prescribed in the basic product specification to which it was ordered.

## 14. Workmanship, Finish and Appearance ASTM F68-05e1

14.1 The product shall be prepared and handled in such a manner as to be substantially free from surface oxide and the presence of foreign material such as metal chips, dirt and grease.

## 15. Sampling

15.1 The sampling practice shall be as prescribed in the basic product specification to which it was ordered.

15.1.1 The number of sample pieces to be selected, however, shall be twice the number prescribed in the basic product specification.

## 16. Number of Tests and Retests

16.1 Tests:

16.1.1The<u>Tests—The</u> number of samples submitted to all tests shall be twice that required by the basic product specification to which the product was ordered.

16.2 Retests:

16.2.1 Retests are permitted as stated in the basic product specification to which the product was ordered for tests associated with the basic product specification.

16.2.2 Retests shall be permitted for tests and examinations required by this specification.

16.2.3 Products which fail in retest shall be rejected.

## **17. Specimen Preparation**

17.1 Chemical Composition:

17.1.1Analytical <u>Composition—Analytical</u> sample preparation shall be as directed in the basic product specification to which the product was ordered.

17.2 Electrical Resistivity:

17.2.1Specimen <u>Resistivity</u>—Specimen preparation shall be as directed in the basic product specification to which the product was ordered.